

## Silicon Carbide Schottky Diode

### Features

- 650V Schottky Rectifier
- Zero Reverse Recovery Current
- High-Frequency Operation
- Temperature-Independent Switching Behavior
- Extremely Fast Switching

$V_{RRM}$	=	650 V
$I_F (T_c=135\text{ }^\circ\text{C})$	=	27 A
$Q_c$	=	90 nC

### Benefits

- Replace Bipolar with Unipolar Rectifiers
- Essentially No Switching Losses
- Higher Efficiency
- Reduction of Heat Sink Requirements
- Parallel Devices Without Thermal Runaway

### Package



### Applications

- Switch Mode Power Supplies (SMPS)
- Power Factor Correction
- Motor Drives



Part Number	Package	Marking
XXX	TO247-2L	XXX

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**Maximum Rated Values (T<sub>c</sub>=25°C unless otherwise specified)**

Symbol	Parameter	Value	Unit	Test Conditions	Note
V <sub>RRM</sub>	Repetitive Peak Reverse Voltage	650	V		
V <sub>R</sub>	DC Peak Reverse Voltage	650	V		
I <sub>F</sub>	Continuous Forward Current	62	A	T <sub>c</sub> =25°C	Fig. 3
		27		T <sub>c</sub> =135°C	
		20		T <sub>c</sub> =150°C	
I <sub>FRM</sub>	Repetitive Peak Forward Surge Current	104	A	T <sub>c</sub> =25°C, t <sub>p</sub> =10 ms, Half Sine Pulse	
		91		T <sub>c</sub> =110°C, t <sub>p</sub> =10 ms, Half Sine Pulse	
I <sub>FSM</sub>	Non-Repetitive Forward Surge Current	130	A	T <sub>c</sub> =25°C, t <sub>p</sub> =10 ms, Half Sine Pulse	
		112.9		T <sub>c</sub> =110°C, t <sub>p</sub> =10 ms, Half Sine Pulse	
I <sub>F,MAX</sub>	Non-Repetitive Forward Surge Current	557	A	T <sub>c</sub> =25°C, t <sub>p</sub> =10μs, Square Wave Pulse	
		422		T <sub>c</sub> =110°C, t <sub>p</sub> =10μs, Square Wave Pulse	
P <sub>tot</sub>	Power Dissipation	192	W	T <sub>c</sub> =25°C	Fig. 4
		83		T <sub>c</sub> =110°C	
T <sub>J</sub>	Operating Temperature	-55 to +175	°C		
T <sub>stg</sub>	Storage Temperature	-55 to +175	°C		
	TO-247 Mounting Torque	1 8.8	Nm lbf-in	M3 Screw 6-32 Screw	

**Electrical Characteristics (T<sub>J</sub>=25°C)**

Symbol	Parameter	Value			Unit	Test Conditions	Note
		Min.	Typ.	Max.			
V <sub>F</sub>	Forward Voltage		1.4	2.0	V	I <sub>F</sub> =20A, T <sub>J</sub> =25°C	Fig. 1
			1.6	2.2		I <sub>F</sub> =20A, T <sub>J</sub> =175°C	
I <sub>R</sub>	Reverse Current		0.8	100	μA	V <sub>R</sub> =650V, T <sub>J</sub> =25°C	Fig. 2
			10			V <sub>R</sub> =650V, T <sub>J</sub> =175°C	
Q <sub>C</sub>	Total Capacitive Charge		90		nC	V <sub>R</sub> =650V, T <sub>J</sub> =25°C	Fig. 5
C	Total Capacitance		1349		pF	V <sub>R</sub> =0V, T <sub>J</sub> =25°C, f=1MHz	Fig. 6
			110			V <sub>R</sub> =400V, T <sub>J</sub> =25°C, f=1MHz	
			108			V <sub>R</sub> =650V, T <sub>J</sub> =25°C, f=1MHz	
E <sub>c</sub>	Capacitance Stored Energy		17		μJ	V <sub>R</sub> =650 V	Fig. 7

**Thermal Characteristics**

Symbol	Parameter	Value	Unit	Note
R <sub>θJC</sub>	Thermal Resistance(Junction to Case)	0.78	°C/W	Fig. 8

### Silicon Carbide Schottky Diode

#### Typical Performance

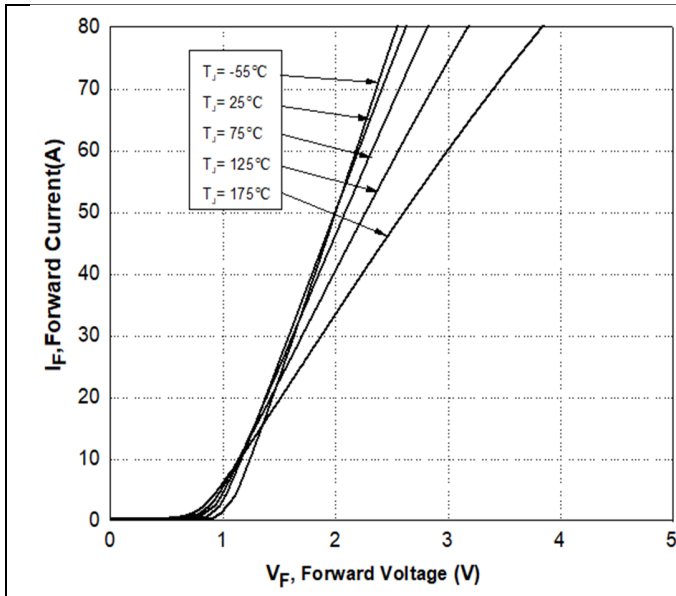


Figure 1. Forward Characteristics

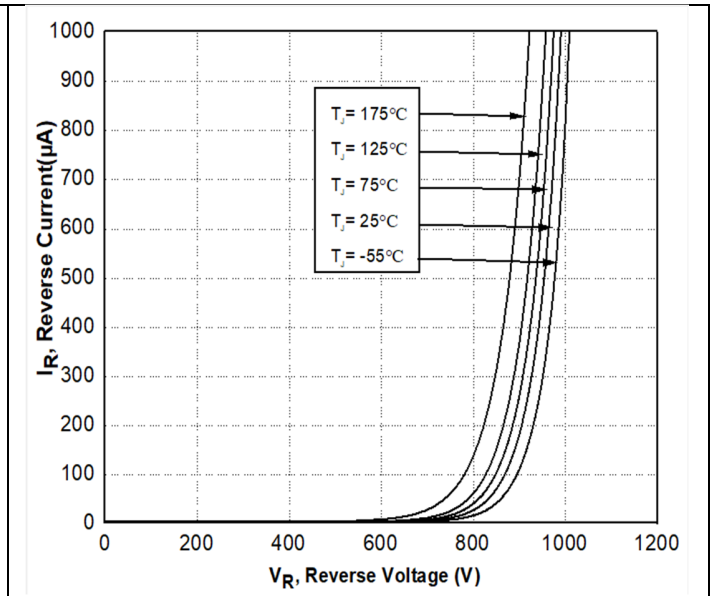


Figure 2. Reverse Characteristics

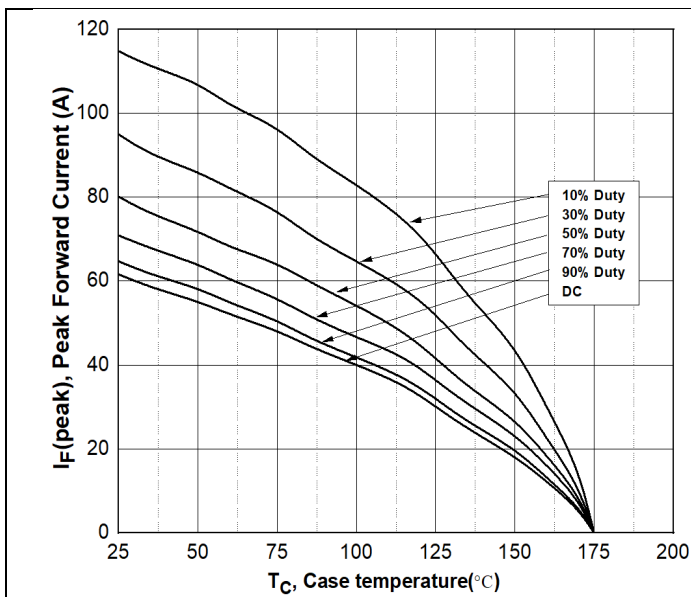


Figure 3. Current Derating

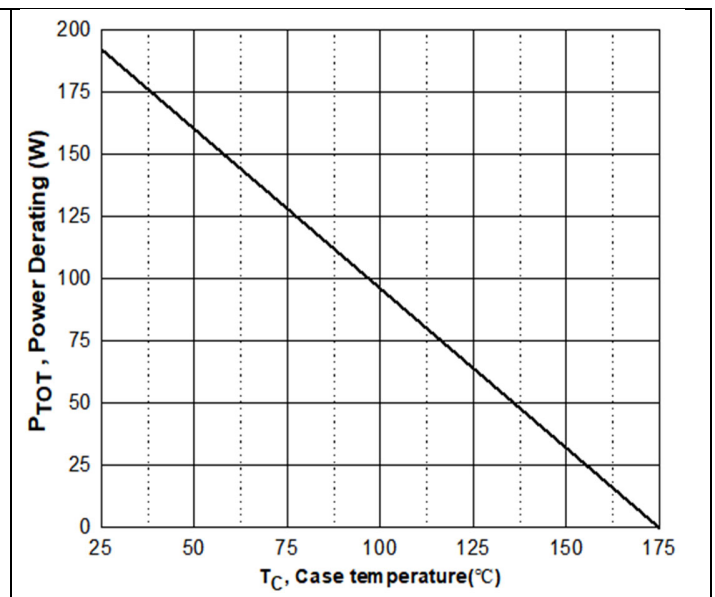


Figure 4. Power Derating

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Typical Performance

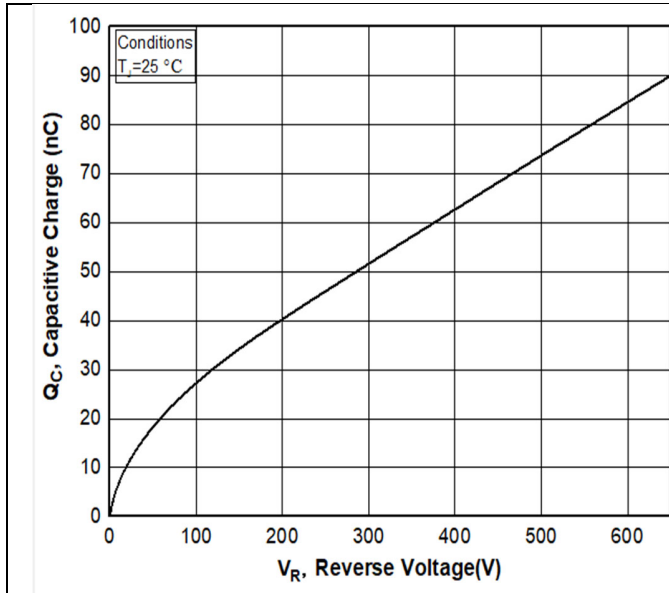


Figure 5. Capacitance Charge Vs. Reverse Voltage

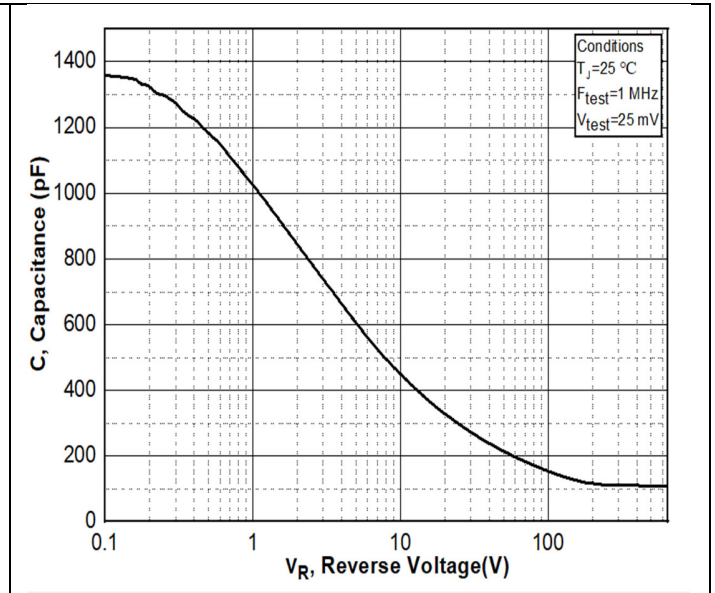


Figure 6. Capacitance Vs. Reverse Voltage

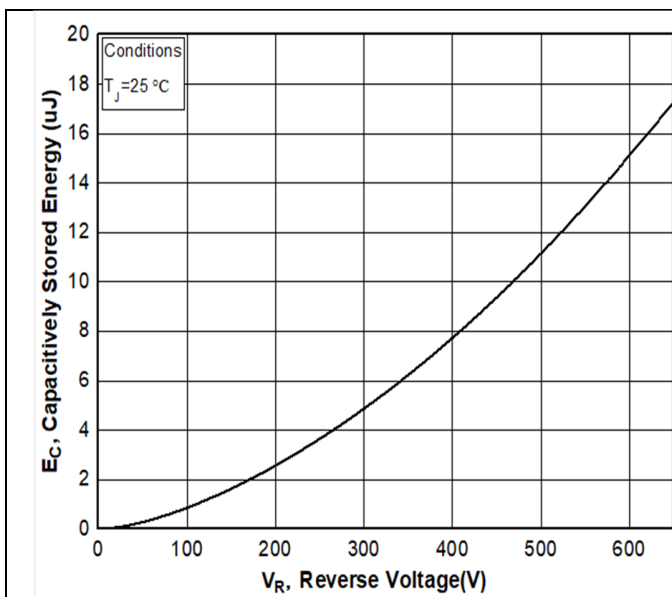


Figure 7. Capacitance Stored Energy

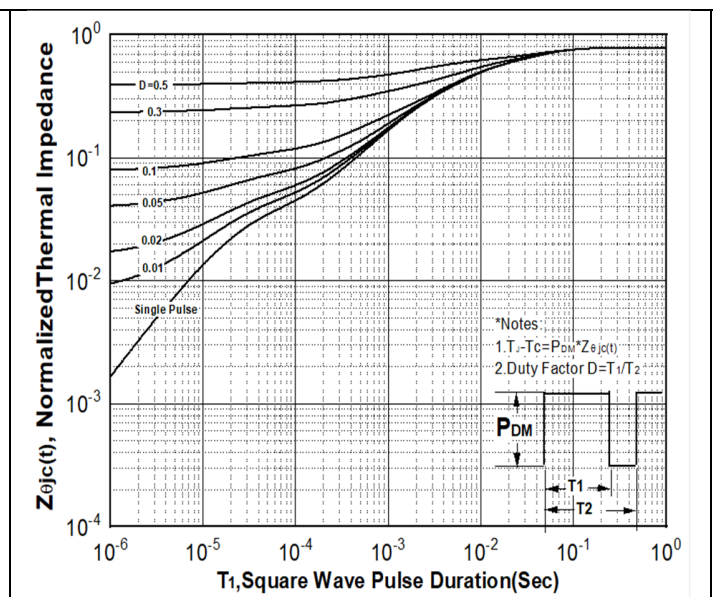


Figure 8. Transient Thermal Response Curve(Junction-to-Case)